

Precision Thin Film Chip Resistor Array



The ACAS 0612 thin film chip resistor arrays combine the proven reliability of precision thin film chip resistor products with the advantages of chip resistor arrays. Defined relative tolerance (matching) and relative TCR (tracking) make this product perfectly suited for applications with outstanding requirements towards stable fixed resistor ratios. A small package enables the design of high density circuits in combination with reduction of assembly costs. The ACAS is available with equal or different resistor values.

FEATURES

- Advanced thin film technology
- Two pairs or four equal resistor values
- Relative TCR down to ± 5 ppm/K (tracking)
- Relative tolerance down to ± 0.05 % (matching)
- Pure Sn termination on Ni barrier layer
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

APPLICATIONS

- Precision analogue circuits
- Voltage divider
- Feedback circuits
- Signal conditioning

| TECHNICAL SPECIFICATIONS | |
|---|--|
| DESCRIPTION | ACAS 0612 |
| EIA size | 0612 |
| Metric size | RR1632M |
| Configuration, isolated | 4 x 0603 |
| Design: | |
| All equal | AE |
| Two pairs | TP |
| Resistance values | 47 Ω to 221 k Ω ⁽¹⁾ |
| Absolute tolerance | ± 0.1 % |
| Relative tolerance | ± 0.05 % |
| Absolute temperature coefficient | ± 25 ppm/K; ± 15 ppm/K; ± 10 ppm/K |
| Relative temperature coefficient | ± 15 ppm/K; ± 10 ppm/K; ± 5 ppm/K |
| Max. resistance ratio R_{min}/R_{max} | 1:5 |
| Rated dissipation: P_{70} | |
| Element | 0.1 W |
| Package, 4 x 0603 | 0.3 W |
| Operating voltage | 75 V |
| Operating temperature range | - 55 °C to 125 °C |
| Permissible film temperature | 125 °C ⁽²⁾ |
| Insulation voltage (U_{ins}) against ambient and between isolated resistors, continuous | 75 V |

Notes

- The relative figures of tolerance, TCR and drift are related to a medial axis between the maximum and minimum permissible deviation of the resistor array. For detailed information please refer to the application note: Increasing Accuracy in Feedback Circuits and Voltage Dividers with Thin Film Chip Resistor Arrays (www.vishay.com/doc?28194).
- ⁽¹⁾ Resistance values to be selected from E24; E192.
- ⁽²⁾ For higher max. film temperature and AEC-Q200 qualification please refer to data sheet ACAS 0606 AT, ACAS 0612 AT - Precision available on our web site at www.vishay.com/doc?28770.

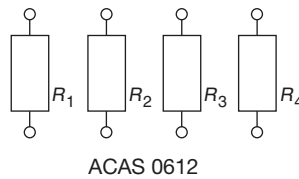
APPLICATION INFORMATION

The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature is not exceeded. These resistors do not feature a limited lifetime when operated within the permissible limits.

| MAXIMUM RESISTANCE CHANGE AT RATED POWER (1) | | | |
|---|------------------|----------------|----------------|
| DESCRIPTION | ACAS 0612 | | |
| Configuration, isolated | 4 x 0603 | | |
| Operation mode | Precision | Standard | |
| Rated power per element, P_{70} | 0.032 W | 0.1 W | |
| Rated power per packaging, P_{70} | 0.1 W | 0.3 W | |
| Film temperature | 85 °C | 125 °C | |
| Operating voltage, U_{max} . AC/DC | 25 V | 75 V | |
| Max. resistance change at P_{70} $\Delta R/R$ max., after: | 1000 h | $\pm 0.1 \%$ | $\pm 0.25 \%$ |
| | 8000 h | $\pm 0.25 \%$ | $\pm 0.5 \%$ |
| Max. relative resistance change (relative drift) at P_{70} $\Delta R/R$ max., after: | 1000 h | $\pm 0.05 \%$ | $\pm 0.125 \%$ |
| | 8000 h | $\pm 0.125 \%$ | $\pm 0.25 \%$ |

Note

(1) Figures are given for arrays with equal values, design type AE.

CIRCUITS


| DESIGN | |
|---------------|-------------------------|
| | ACAS 0612 |
| AE | $R_1 = R_2 = R_3 = R_4$ |
| TP | $R_1 = R_4 < R_2 = R_3$ |



| PART NUMBER AND PRODUCT DESCRIPTION | | | | | | | | | | | | | | | | | |
|---|--------------------------------------|-------------------------|--|---|---|--|---|-------------------------------------|---------------------------------|---|---|---|---|---|---|---|---|
| Part Number: ACASA1100S2200P500 | | | | | | | | | | | | | | | | | |
| A | C | A | S | A | 1 | 1 | 0 | 0 | S | 2 | 2 | 0 | 0 | P | 5 | 0 | 0 |
| MODEL/SIZE ACA | TERMINAL S = Convex square | SIZE A = 0612 | RESISTANCE ⁽¹⁾ 3 digit resistance value R₁, R₄ 1 digit multiplier MULTIPLIER 9 = *10 ⁻¹ 0 = *10 ⁰ 1 = *10 ¹ 2 = *10 ² 3 = *10 ³ | | ACCURACY GRADE ⁽²⁾ TCR, tracking, tolerance and matching S, T, or U | RESISTANCE ⁽¹⁾ 3 digit resistance value R₂, R₃ 1 digit multiplier MULTIPLIER 9 = *10 ⁻¹ 0 = *10 ⁰ 1 = *10 ¹ 2 = *10 ² 3 = *10 ³ | | PACKAGING P1 P5 | SPECIAL 00 = Standard | | | | | | | | |
| Product Description: ACAS 0612 110R S 220R P5 | | | | | | | | | | | | | | | | | |
| ACA | S | 0612 | 110R | | S | 220R | | P5 | | | | | | | | | |
| MODEL/SIZE | TERMINAL | SIZE | RESISTANCE R ₁ , R ₄ ⁽¹⁾ | | ACCURACY GRADE ⁽²⁾ | RESISTANCE R ₂ , R ₃ ⁽¹⁾ | | PACKAGING | | | | | | | | | |
| ACA = Chip array | S = Convex square | 0612 | 110R = 110 Ω 1K1 = 1.1 kΩ 22K1 = 22.1 kΩ | | TCR, tracking, tolerance and matching S, T, or U | 220R = 220 Ω 1K1 = 1.1 kΩ 22K1 = 22.1 kΩ | | P1 P5 | | | | | | | | | |

Notes

- Products can be ordered using either the PART NUMBER or the PRODUCT DESCRIPTION.
- ⁽¹⁾ R₁ = R₄ ≤ R₂ = R₃.
- ⁽²⁾ For historical temperature coefficient and resistance ranges please refer to the end of the data sheet.

| TEMPERATURE COEFFICIENT AND RESISTANCE RANGE | | | | | | |
|--|----------------|------------|-----------|------------|-----------|------------------|
| TYPE | ACCURACY GRADE | ABSOLUTE | | RELATIVE | | RESISTANCE VALUE |
| | | TCR | TOLERANCE | TCR | TOLERANCE | |
| ACAS 0612 | S | ± 25 ppm/K | ± 0.1 % | ± 15 ppm/K | ± 0.05 % | 47 Ω to 221 kΩ |
| | T | ± 15 ppm/K | ± 0.1 % | ± 10 ppm/K | ± 0.05 % | 47 Ω to 150 kΩ |
| | U | ± 10 ppm/K | ± 0.1 % | ± 5 ppm/K | ± 0.05 % | 47 Ω to 100 kΩ |

Notes

- For historical temperature coefficient and resistance range please refer to the end of the data sheet.
- Relative TCR (tracking) down to ± 2.5 ppm/K on request.
- Relative tolerance for resistance values < 80 Ω on request.

| PACKAGING | | | | | | |
|-----------|------|----------|--|-------|-------|---------------|
| TYPE | CODE | QUANTITY | PACKAGING STYLE | WIDTH | PITCH | REEL DIAMETER |
| ACAS 0612 | P1 | 1000 | Tape and reel cardboard tape acc. IEC 60286-3 Type I | 8 mm | 4 mm | 180 mm/7" |
| | P5 | 5000 | | | | |

DIMENSIONS


| DIMENSION AND MASS | | | | | | | | | |
|--------------------|------------|------------|------------|-----------|---------------------|-----------|---------------------|---------------------|-----------|
| TYPE | L (mm) | W (mm) | H (mm) | P (mm) | A ₁ (mm) | A (mm) | T ₁ (mm) | T ₂ (mm) | MASS (mg) |
| ACAS 0612 | 1.5 ± 0.15 | 3.2 ± 0.15 | 0.45 ± 0.1 | 0.8 ± 0.1 | 0.6 ± 0.1 | 0.4 ± 0.1 | 0.3 ± 0.15 | 0.4 ± 0.15 | 6.6 |

PATTERN STYLES FOR CHIP RESISTOR ARRAY

ACAS 0612


 Dimensions in mm
 limits for solder resist

| RECOMMENDED SOLDER PAD DIMENSIONS | | | | | | | |
|-----------------------------------|--------|--------|--------|--------|--------|--------|--------|
| TYPE | G (mm) | Y (mm) | X (mm) | U (mm) | Z (mm) | I (mm) | P (mm) |
| ACAS 0612 | 0.7 | 0.7 | 0.64 | 0.5 | 2.1 | 0.3 | 0.8 |



DESCRIPTION

The production of the components is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of metal alloy is deposited on a high grade (96 % Al₂O₃) ceramic substrate using a mask to separate the adjacent resistors and conditioned to achieve the desired temperature coefficient. Specially designed inner contacts are realized on both sides. A special laser is used to achieve the target value by smoothly cutting a meander groove in the resistive layer without damaging the ceramics.

The resistor elements are covered by a protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure tin on nickel plating.

The result of the determined production is verified by an extensive testing procedure and optical inspection performed on 100 % of the individual chip resistors. Only accepted products are laid directly into the paper tape in accordance with IEC 60286-3 (3).

ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using reflow or vapour phase as shown in IEC 61760-1 (3). The encapsulation is resistant to all cleaning solvents commonly used in the electronics

industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system. The resistors are RoHS compliant; the pure tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. The permitted storage time is 20 years, whereas the solderability is specified for 2 years after production or requalification. The immunity of the plating against tin whisker growth has been proven under extensive testing.

All products comply with the GADSL (1) and the CEFIC-EECA-EICTA (2) list of legal restrictions on hazardous substances. This includes full compliance with the following directives:

- 2000/53/EC End of Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EC Restriction of the use of Hazardous Substances directive (RoHS)
- 2002/96/EC Waste Electrical and Electronic Equipment Directive (WEEE)

TESTS

Where applicable, the resistors are tested in accordance with EN 140401-801 which refers to EN 60115-1 and EN 140400.

Notes

- (1) Global Automotive Declarable Substance List, see www.gadsl.org.
- (2) CEFIC (European Chemical Industry Council), EECA (European Electronic Component Manufacturers Association), EICTA (European trade organisation representing the information and communications technology and consumer electronics), see www.eicta.org → policy → environmental policy group → chemicals → jig → Joint Industry Guide (JIG-101 Ed 2.0).
- (3) The quoted IEC standards are also released as EN standards with the same number and identical contents.

FUNCTIONAL PERFORMANCE



For permissible resistance change please refer to table MAXIMUM RESISTANCE CHANGE AT RATED POWER

Derating



TESTS AND REQUIREMENTS

Essentially all tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification

EN 140400, sectional specification

EN 140401-801, detail specification

The testing also covers most of the requirements specified by EIA/IS-703 and JIS-C-5202.

The tests are carried out in accordance with **IEC 60068 (1)** and under standard atmospheric conditions according to **IEC 60068-1 (1)**, 5.3. Climatic category LCT/UCT/56 (rated temperature range: Lower category temperature, upper

category temperature; damp heat, long term, 56 days) is valid (LCT = - 55 °C/UCT = 125 °C).

Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C

Relative humidity: 45 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar)

The requirements stated in the “Test Procedures and Requirements” table are based on the required tests and permitted limits of EN 140401-801 where applicable.

| TEST PROCEDURES AND REQUIREMENTS | | | | |
|----------------------------------|-----------------------------|--|---|--|
| EN 60115-1 CLAUSE | IEC 60068-2 (1) TEST METHOD | TEST | PROCEDURE | REQUIREMENTS PERMISSIBLE CHANGE (2) (ΔR) |
| | | | Stability for product types: ACAS 0612 | 47 Ω to 221 kΩ |
| 4.5 | - | Resistance | - | ± 0.1 % R |
| 4.8.4.2 | - | Temperature coefficient | At (20/-55/20) °C and (20/125/20) °C | ± 25 ppm/K; ± 15 ppm/K; ± 10 ppm/K |
| 4.25.1 | - | Endurance at 70 °C: Precision operation mode | $U = \sqrt{P_{70} \times R}$ or $U = U_{max.}$; 1.5 h on; 0.5 h off; whichever is the less severe; 1000 h: Absolute Relative 8000 h: Absolute Relative | ± (0.1 % R + 0.05 Ω) ± (0.05 % R + 0.05 Ω) ± (0.25 % R + 0.05 Ω) ± (0.125 % R + 0.05 Ω) |
| | | Endurance at 70 °C: Standard operation mode | $U = \sqrt{P_{70} \times R}$ or $U = U_{max.}$; 1.5 h on; 0.5 h off; whichever is the less severe; 1000 h: Absolute Relative 8000 h: Absolute Relative | ± (0.25 % R + 0.05 Ω) ± (0.125 % R + 0.05 Ω) ± (0.5 % R + 0.05 Ω) ± (0.25 % R + 0.05 Ω) |
| 4.25.3 | - | Endurance at upper category temperature | 85 °C; 1000 h: Absolute Relative | ± (0.1 % R + 0.05 Ω) ± (0.05 % R + 0.05 Ω) |
| | | | 125 °C; 1000 h: Absolute Relative | ± (0.25 % R + 0.05 Ω) ± (0.125 % R + 0.05 Ω) |
| 4.24 | 78 (Cab) | Damp heat, steady state | (40 ± 2) °C; 56 days; (93 ± 3) % RH | ± (0.25 % R + 0.05 Ω) |
| 4.13 | - | Short time overload (3) Standard operation mode | $U = 2.5 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{max.}$; 5 s | ± (0.1 % R + 0.01 Ω) no visible damage |
| 4.19 | 14 (Na) | Rapid change of temperature | 30 min at - 55 °C and 30 min at 125 °C; 5 cycles | ± (0.1 % R + 0.01 Ω) no visible damage |



| TEST PROCEDURES AND REQUIREMENTS | | | | |
|----------------------------------|-----------------------------|------------------------------|--|--|
| EN 60115-1 CLAUSE | IEC 60068-2 (1) TEST METHOD | TEST | PROCEDURE | REQUIREMENTS PERMISSIBLE CHANGE (2) (ΔR) |
| | | | Stability for product types: ACAS 0612 | 47 Ω to 221 kΩ |
| 4.18.2 | 58 (Td) | Resistance to soldering heat | Reflow method 2 (IR/forced gas convection); (260 \pm 5) $^{\circ}$ C; (10 \pm 1) s | \pm (0.1 % R + 0.01 Ω) no visible damage |
| 4.17.2 | 58 (Td) | Solderability | Solder bath method; SnPb; non-activated flux accelerated ageing 4 h/155 $^{\circ}$ C (215 \pm 3) $^{\circ}$ C; (3 \pm 0.3) s Solder bath method; SnAgCu; non-activated flux accelerated ageing 4 h/155 $^{\circ}$ C (235 \pm 3) $^{\circ}$ C; (2 \pm 0.2) s | Good tinning (\geq 95 % covered); no visible damage |
| 4.32 | 21 (Ue ₃) | Shear (adhesion) | 45 N | No visible damage |
| 4.33 | 21 (Ue ₁) | Substrate bending | Depth 2 mm, 3 times | \pm (0.1 % R + 0.01 Ω) no visible damage; no open circuit in bent position |
| 4.7 | - | Voltage proof | $U_{RMS} = U_{ins}$ (60 \pm 5) s; against ambient, between adjacent resistors | No flashover or breakdown |

Notes

- (1) The quoted IEC standards are also released as EN standards with the same number and identical contents.
- (2) Figures are given for arrays with equal values, design type AE.
- (3) For a single element.

| HISTORICAL TEMPERATURE COEFFICIENT AND RESISTANCE RANGES | | | | | |
|--|----------------|--------------|--------------------|--------------------|-------------------------------|
| DESCRIPTION | | | | | RESISTANCE VALUE |
| ACCURACY GRADE | ABSOLUTE TCR | TCR TRACKING | ABSOLUTE TOLERANCE | TOLERANCE MATCHING | ACAS 0612 |
| A | \pm 25 ppm/K | 10 ppm/K | \pm 0.25 % | 0.1 % | 47 Ω to 221 k Ω |
| B | \pm 25 ppm/K | 10 ppm/K | \pm 0.5 % | 0.25 % | 47 Ω to 221 k Ω |
| E | \pm 25 ppm/K | 15 ppm/K | \pm 0.25 % | 0.1 % | 47 Ω to 221 k Ω |
| F | \pm 25 ppm/K | 15 ppm/K | \pm 0.5 % | 0.25 % | 47 Ω to 221 k Ω |
| J | \pm 25 ppm/K | 25 ppm/K | \pm 0.25 % | 0.1 % | 47 Ω to 221 k Ω |
| K | \pm 25 ppm/K | 25 ppm/K | \pm 0.5 % | 0.25 % | 47 Ω to 221 k Ω |
| N | \pm 50 ppm/K | 25 ppm/K | \pm 0.5 % | 0.5 % | 47 Ω to 221 k Ω |
| P | \pm 50 ppm/K | 50 ppm/K | \pm 0.5 % | 0.5 % | 47 Ω to 221 k Ω |

Note

- Special temperature coefficient and resistance combinations remain available. For optimized availability please refer to the table TEMPERATURE COEFFICIENT AND RESISTANCE.



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